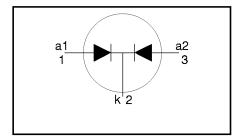
BYQ28E, BYQ28EB, BYQ28ED series

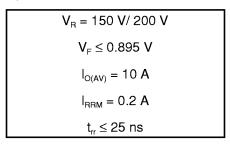
FEATURES

- · Low forward volt drop
- Fast switching
- Soft recovery characteristic
- Reverse surge capability
- High thermal cycling performance
- · Low thermal resistance

SYMBOL



QUICK REFERENCE DATA



GENERAL DESCRIPTION

Dual, ultra-fast, epitaxial rectifier diodes intended for use as output rectifiers in high frequency switched mode power supplies.

The BYQ28E series is supplied in the SOT78 conventional leaded package.

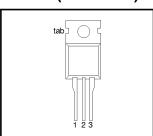
The BYQ28EB series is supplied in the SOT404 surface mounting package.

The BYQ28ED series is supplied in the SOT428 surface mounting package.

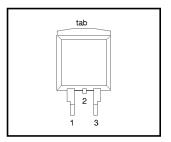
PINNING

PIN	DESCRIPTION
1	anode 1
2	cathode ¹
3	anode 2
tab	cathode

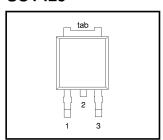
SOT78 (TO220AB)



SOT404



SOT428



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	I. MAX.		UNIT
		BYQ28E/ BYQ28EB/ BYQ28ED		-150	-200	
V_{RRM}	Peak repetitive reverse		-	150	200	V
V_{RWM}	voltage Working peak reverse voltage		-	150	200	V
V_{R}	Continuous reverse voltage		-	150	200	v
I _{O(AV)}	Average rectified output current (both diodes conducting)	square wave; $\delta = 0.5$; $T_{mb} \le 119$ °C	-	1	0	A
I _{FRM}	Repetitive peak forward current per diode	square wave; $\delta = 0.5$; $T_{mb} \le 119$ °C	-	1	0	A
I _{FSM}	Non-repetitive peak forward current per diode	t = 10 ms t = 8.3 ms	-		0 5	A A
I _{RRM}	Peak repetitive reverse surge current per diode	sinusoidal; with reapplied $V_{\text{RRM}(\text{max})}$ $t_p = 2 \ \mu\text{s}; \ \delta = 0.001$	-	0	.2	A
I _{RSM}	Peak non-repetitive reverse	t _p = 100 μs	-	0	.2	Α
T _j	surge current per diode Operating junction temperature		-	150		°C
T_{stg}	Storage temperature		- 40	15	50	°C

^{1.} It is not possible to make connection to pin 2 of the SOT428 or SOT404 packages.

BYQ28E, BYQ28ED series

ESD LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _c	Electrostatic discharge capacitor voltage	Human body model; C = 250 pF; R = 1.5 kΩ	-	8	kV

THERMAL RESISTANCES

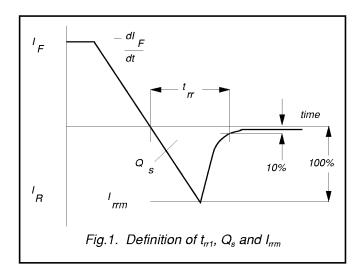
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Thermal resistance junction to mounting base	per diode both diodes	1 1		4.5 3	K/W K/W
R _{th j-a}	Thermal resistance junction to ambient	SOT78 package, in free air SOT404 and SOT428 packages, pcb mounted, minimum footprint, FR4 board	1 1	60 50	1 1	K/W K/W

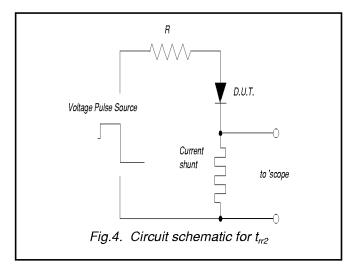
ELECTRICAL CHARACTERISTICS

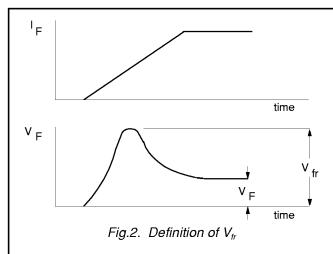
All characteristics are per diode at $T_i = 25$ °C unless otherwise specified

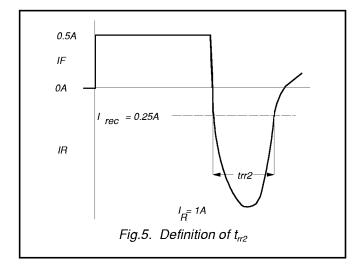
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage	$I_F = 5 \text{ A}; T_i = 150^{\circ}\text{C}$	-	0.8	0.895	٧
	_	$I_{\rm F} = 5 \text{A}$	-	0.95	1.1	V
		$I_{\rm F} = 10 {\rm A}$	-	1.1	1.25	V
l _B	Reverse current	$V_R = V_{RWM}$	-	2	10	μΑ
		$V_{\rm B} = V_{\rm BWM}$; $T_{\rm i} = 100^{\circ}{\rm C}$	-	0.1	0.2	mΑ
Q_{rr}	Reverse recovered charge	l l₂ = 2 A: V₂ ≥ 30 V: -dl₂/dt = 20 A/μs	-	4	9	nC
t _{rr1}	Reverse recovery time	$I_{F} = 1 \text{ A}'; V_{R}'' \ge 30 \text{ V}'; -dI_{F}'/dt = 100 \text{ A}'/\mu \text{s}$		15	25	ns
t _{rr2}	Reverse recovery time	$I_F = 0.5 \text{ A to } I_R = 1 \text{ A}; I_{rec} = 0.25 \text{ A}$ $I_F = 5 \text{ A}; V_B \ge 30 \text{ V}; -dI_F/dt = 50 \text{ A}/\mu\text{s}$	-	10	20	ns
I _{rrm}	Peak reverse recovery current	$I_F = 5 \text{ A}; V_R \ge 30 \text{ V}; -dI_F/dt = 50 \text{ A}/\mu\text{s}$	-	0.5	0.7	Α
V_{fr}	Forward recovery voltage	$I_F = 1 \text{ A}; dI_F/dt = 10 \text{ A/}\mu\text{s}$	-	1	-	V

BYQ28E, BYQ28ED series









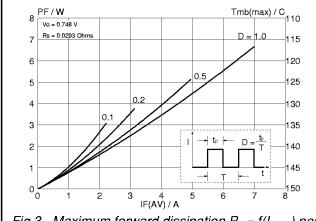


Fig.3. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; square current waveform where $I_{F(AV)} = I_{F(RMS)} x \sqrt{D}$.

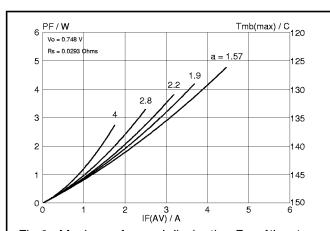
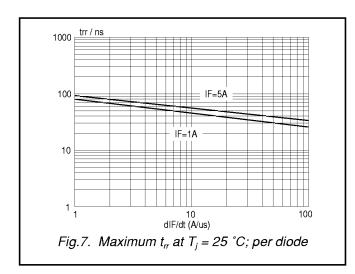
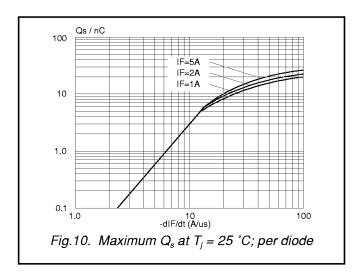
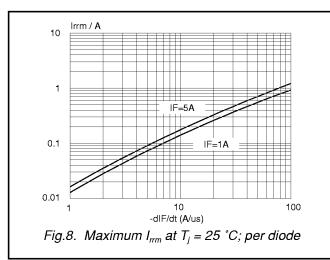


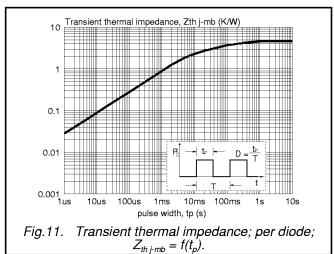
Fig.6. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; sinusoidal current waveform where a = form factor $= I_{F(RMS)} / I_{F(AV)}$.

BYQ28E, BYQ28ED series









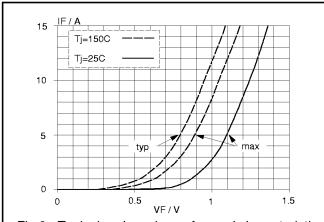
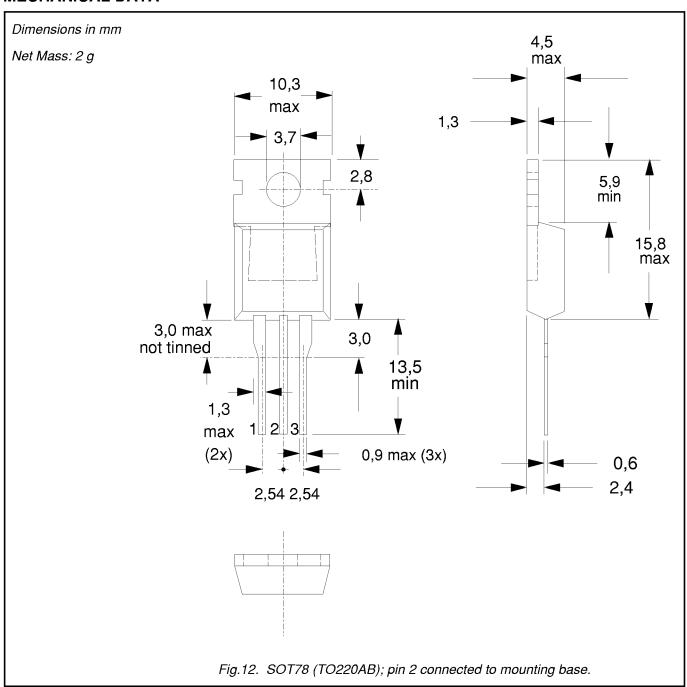


Fig.9. Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_j

BYQ28E, BYQ28ED series

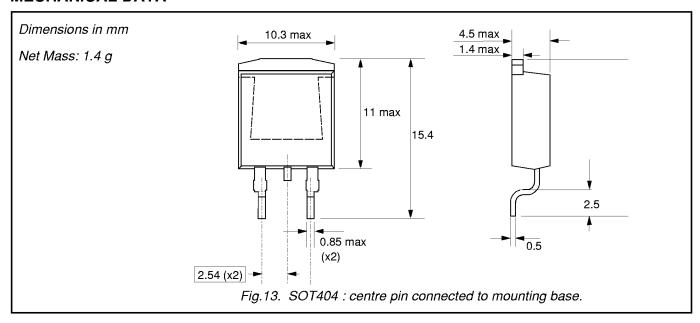
MECHANICAL DATA



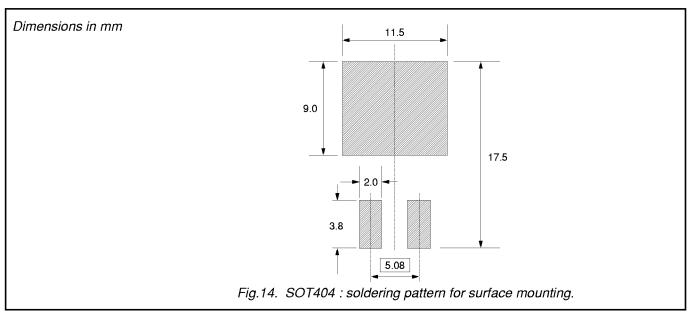
- Notes
 1. Refer to mounting instructions for SOT78 (TO220) envelopes.
 2. Epoxy meets UL94 V0 at 1/8".

BYQ28E, BYQ28ED series

MECHANICAL DATA



MOUNTING INSTRUCTIONS

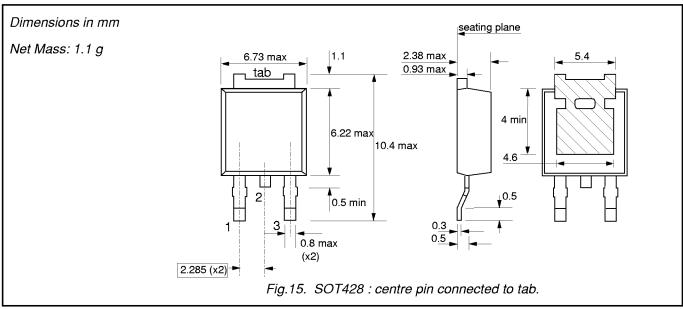


Notes

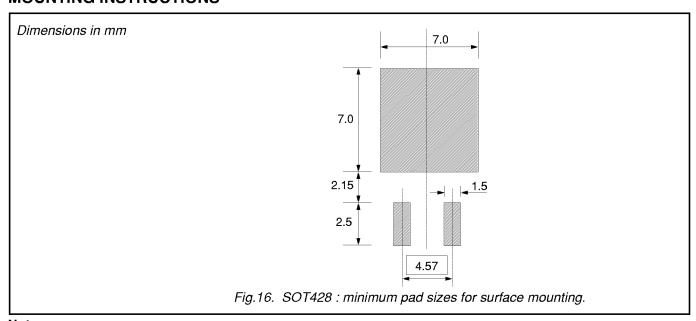
1. Epoxy meets UL94 V0 at 1/8".

BYQ28E, BYQ28ED series

MECHANICAL DATA



MOUNTING INSTRUCTIONS



Notes

1. Plastic meets UL94 V0 at 1/8".

BYQ28E, BYQ28ED series

DEFINITIONS

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values				

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of

this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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BYQ28E, BYQ28ED series

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